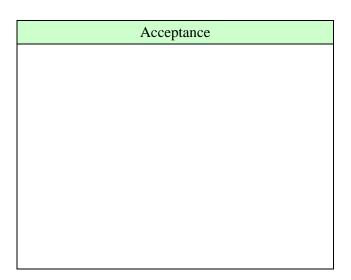
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Product Specification	Model	MTF-TQ28NN911-LB	Rev. No.	Issued Date.	Page.
Froduct Specification	Model.	MIT-1Q20111911-LD	Α	Feb.27,09	1/27

LIQUID CRYSTAL DISPLAY MODULE MODEL: MTF-TQ28NN911-LB Customer's No.:



Microtips Technology Inc. 12F. No.31 Lane 169, Kang Ning St., His-Chih, Taipei Hsien, Taiwan FAX: 886-2-26958625

Approved and Checked by

Approved by	Check	Made by	
微端	微端	微端	微端
2009/02/27	2009/02/27	2009/02/27	2009/02/27
李剛	蔡宜夢	陳世文	許瓊窈



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Fioduce specification	widder.	WIIF-IQ20NN911-LD	Α	Feb.27,09	2/27

Revise Records

Rev.	Date	Contents	Written	Approved
А	2009/02/27	Specification released	Jill Hsu	Steele Lee

Special Notes

Note1.	
Note2.	
Note3.	
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1. <u>GENERAL DESCRIPTION</u>

The MTF-TQ28NN911-LB is a Color TFT LCD supplied by Microtips. This main Module has a 2.8 inch Diagonally measured active display area with 240 x RGB x 320 Resolution. Each pixel is divided into Red, Green and Blue sub-pixels and dots which are arranged in vertical stripes. LCD color is determined with Dithering 65K/262K Color signal for each pixel. The MTF-TQ28NN911-LB has been designed to apply the interface method that enables low power, high speed, and high contrast. The MTF-TQ28NN911-LB is intended to support Applications where thin thickness, wide viewing angle, low power are critical factors and graphic displays are important.

2. FEATURES

Display Mode	TFT module, Transmissive Type, Positive mode			
Display Format	RGB vertical stripe			
Color	56K/262K color			
Input Data	MCU Mode : 8080 system ; 8/9/16/18 bits interface			
Viewing Direction	12 O'clock			
Backlight	White LED			



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3. MECHANICAL SPECIFICATION

Item	Specifications	Unit
Dimensional outline	50 (W) × 69.2 (H) × 2.8 (D)	mm
Resolution	240 x RGB x 320	Pixel
Active area	43.2 (W) × 57.6 (H)	mm
Pixel pitch	0.18 (W) × 0.18 (H)	mm
Dots pitch	0.06 (W) × 0.18 (H)	mm

* Not: Include FPC

* 1 Pixel =3 dots = Red dot + Green dot + Blue dot



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4. ELECTRICAL CHARACTERISTICS

		1 ypica	ii operating coi	iditions (GND	=Av ss $=$ 0v)
Item	Symbol	Min	Тур	Max	Units
Dowor Supply	VDD		2.8		V
Power Supply	IDD		10	12	mA
Consumption current of	VLED			3.5	V
VLED	ILED		80		mA
Operating Temperature	Тор	-20		70	°C
Storage Temperature	Tstg	-30		80	°C
Humidity			90	%RH	Note1

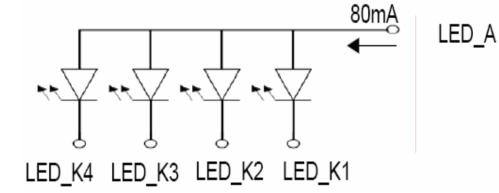
Typical operating conditions (GND=AV ss=0V)

Note1: TA \leq 40°C Without dewing

4.1 Backlight Characteristic

Item	Symbol	Condition	Min	Тур	Max	Units
LED module voltage	VLED	ILED=20mA			3.5	V
LED module current	ILED	VLED=3.5V		80		mA
Surface brightness	Lp	ILED=80mA	75	80		%
uniform (without LCD)	Ld	VLED=3.5V	15	80		70

* 1 Backlight LED Circuit:

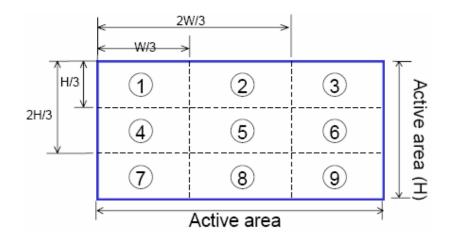




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* 2 Uniform measure condition :

- (a) Measure 9 point. Measure location is show below :
- (b) Uniform = (Min. brightness / Max. brightness) * 100%
- (c) Best Contrast, Main and sub panel All dots tum ON (White screen)





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4.2 Pin Description

No	Pin Name			Functions				
1	VDD	Power inp	Power input (+2.8V)					
2	VDD	Power inp	Power input (+2.8V)					
3	GND	Power Gr	ound					
4	GND	Power Gr	ound					
5	CS	Chip Sele	ct Input PI	IN				
6	RS	Register S	Select Inpu	ut PIN				
7	WR	Chip Sele	ct Input PI	IN				
8	RD	Read Data	a Select In	nput PIN				
9~26	DB0~DB17	Data Bus	Pin					
27	RESET	Reset Sele	ect Input P	PIN				
28	GND	Power Gro	ound					
		Mode Sele	ect					
		IM0	IM3	Interface				
20.20		0	1	8-bits				
29~30	IM0~IM3	1	1	9-bits				
		0	0	16-bits				
		1	0	18-bits				
31	K4	B/L Powe	r input PI	N negative				
32	K3	B/L Powe	r input PI	N negative				
33	K2	B/L Powe	r input PI	N negative				
34	K1	B/L Powe	r input PI	N negative				
35	AN	B/L Pow	er input PI	IN anode				
36	NC/ YU	Not Com	nect					
37	NC/ XL	Not Conn	ect					
38	NC/ YD	Not Conn	ect					
39	NC/ XR	Not Conn	ect					
80-sy 80-sy	rstem 8-bits used I rstem 9-bits used I rstem 16-bits used rstem 18-bits used	DB17 : DB9 DB17 : DB	10 and DE	B7 : DB0				



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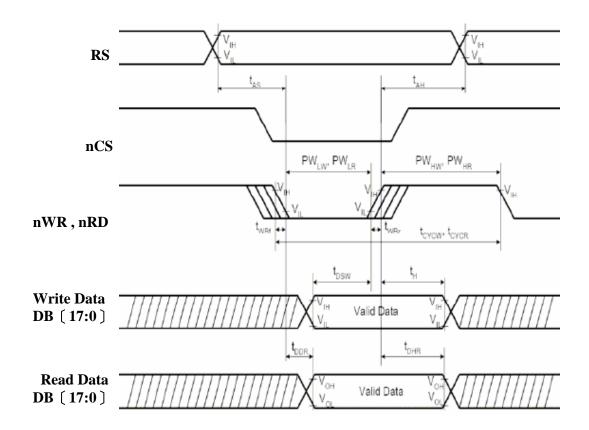
4.3 System Interface

4.3.1 8080-System Interface Timing

Item		Symbol	Unit	Min	Тур	Max	Test Condition	
Write		tcycw	ns	100				
Bus	cycle time	Read	tcycr	ns	300			
Write lo	w-level pulse widtl	n	PWLW	ns	50		500	
Write hi	gh-level pulse widt	h	PW _{HW}	ns	50			
Read lov	w-level pulse width	l	PWLR	ns	150			
Read hig	gh-level pulse widt	h	PWhr	ns	150			
Write / I	Read rise / fall time		twr/twrf	ns			25	
Catar	Write (RS to NCS)	E/NWR)			10			
Setup time	Read (RS to NCS	,RW/NRD)	tas	ns	5			
Address	hold time		tан	ns	5			
Write d	Write data set up time		tdsw	ns	10			
Write data hold time		tн	ns	15				
Read data delay time		tddr	ns			100		
Read da	ata hold time		tdhr	ns	5			



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^{4.3.2} Reset Timing

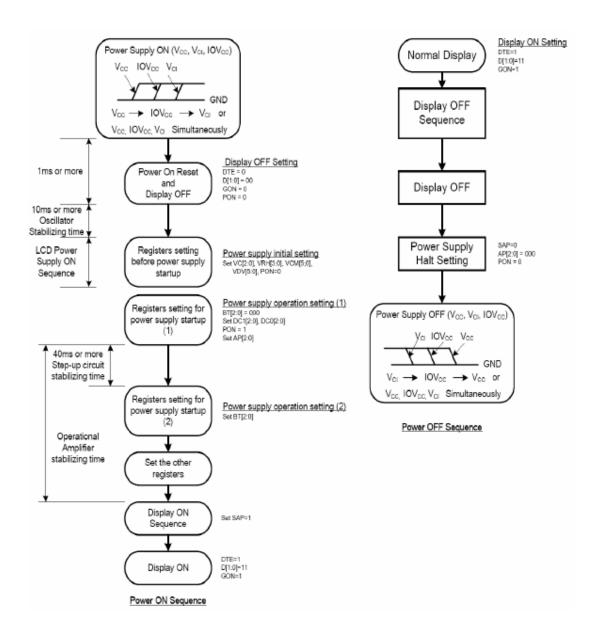
Item	Symbol	Units	Min	Тур	Max
Reset Low-Level Width	tres	ms	1		
Reset Rise Time	tres	us			10





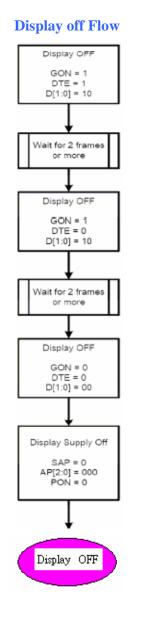
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4.3.3 Power ON/OFF

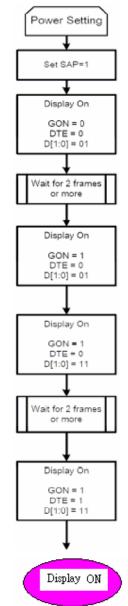


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4.3.4 Display ON/OFF







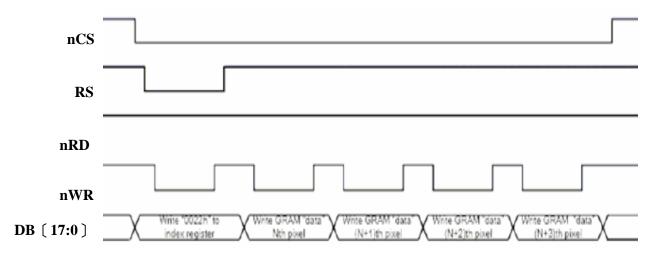


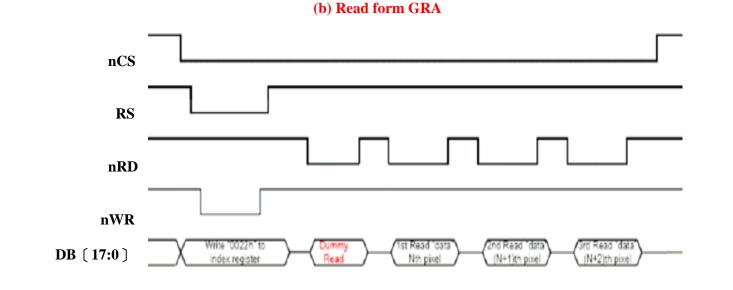
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Product Specification Mode	Model		Rev. No.	Issued Date.	Page.				
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4.4 GRAM Address Map & Read / Write

<u>! 80 18-/16-bit System Bus Interface Timing</u>



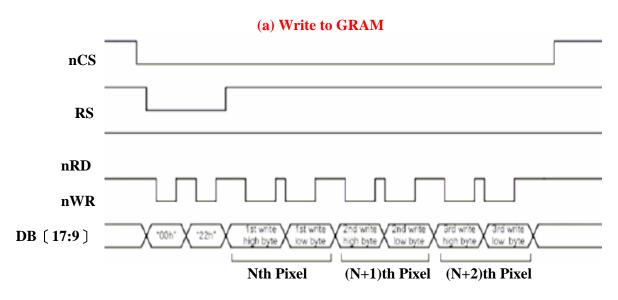




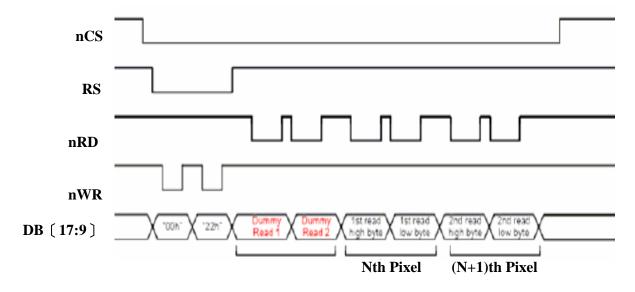


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<u>! 80 9-/ 8-bit System Bus Interface Timing</u>



(b) Read form GRA





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5. ELECTRO-OPTICAL CHARACTERISTICS

Parameter		Symbol.	Min.	Тур.	Max.	Units.	Note.
Luminance of white		Lwh	220			cd/m ²	
Contrast Ratio		CR		300			* 5
Response Tim	e (Tr+Tf)			30		ms	* 4
	X axis right ($\phi = 0^\circ$)	θx		60			
Viewing	X axis left ($\phi = 180^{\circ}$)	θx		60			* 6
Angle (CR≧10)	Y axis up ($\phi = 90^{\circ}$)	θу		60		Degree	
	Y axis down ($\phi = 270^{\circ}$)	θу		50			
	White	Wx	0.290	0.310	0.330		
	white	Wy	0.323	0.343	0.363		
	Red	Rx	0.584	0.604	0.624		
CIE color	Keu	Ry	0.305	0.325	0.345		BM7;
Coordinates	Green	Gx	0.279	0.299	0.319		2° angle
	Gieen	Gy	0.547	0.567	0.587		
	Blue	Bx	0.115	0.135	0.155		
	Diue	By	0.127	0.147	0.167		

For LCM •

Note1: Ambient temperature= $25^{\circ}C \pm 2^{\circ}C$.

Note2: To be measured in the dark room.

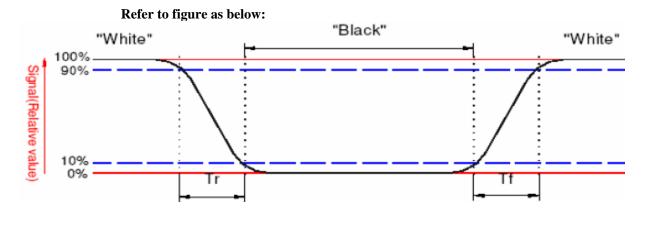
Note3: To be measured at the center area of panel with a viewing cone of $2^\circ\,$ by Topcon luminance meter BM-7, after 10 minutes operation (module).

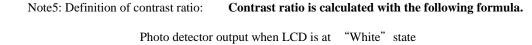


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Note4: Definition of response time:

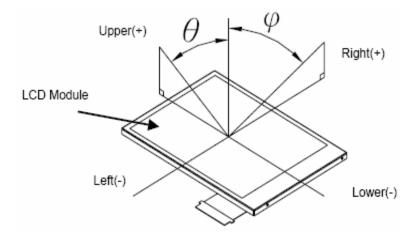
The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes.







Note6: Definition of viewing angle (LCD-5200): Refer to the figure as below





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RELIABILITY 6.

MTTF 6.1

The LCD module shall be designed to meet a minimum MTTF value of 50,000 hours with normal condition. (25°C in the room without sunlight; not include life time of backlight)

6.2 Tests

NO	Item	Condition	Criterion
1	High Temperature Operating	70°C 240hrs	* No defect of
2	Low Temperature Operating	-20°C 240hrs	Operational function in
3	High Temperature Non-Operating	80°C 240hrs	Room temperature are Allowable.
4	Low Temperature Non-Operating	-30°C 240hrs	
5	High Temperature / Humidity Non-Operating	50°C , 90%HR 240hrs	* Leakage current should Be below double of initial
6	Temperature Shock Non-Operating	$\begin{array}{rrrr} -30^{\circ}\mathbb{C} & \longleftrightarrow & 80^{\circ}\mathbb{C} \\ (30\text{min}) & (5\text{min}) & (30\text{min}) \\ & 10 & \text{CYCLES} \end{array}$	value.
	Electro-static Discharge	HBM : ±2Kv	

Note1: Test after 24 hours in room temperature.

Note2: The sampling above is Individually for each reliability testing condition.

Note3: The color fading of polarizing filter should not care.

Note4: All of the reliability testing chamber above, is using D.I. water. (Min value: $1.0 \text{ M}\Omega$ -cm)

Note5: In case of malfunction defect caused by ESD damage, if it would be recovered to

Normal state after resetting, it would be judged as a good part.



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7. INSPECTION CRITERIA

7.1 Inspection Conditions

Environmental conditions

The environmental conditions for inspection shall be as follows Room temperature: 23±5°C

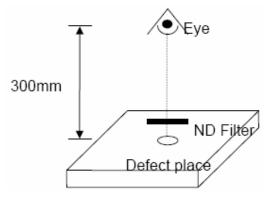
Humidity: 50±20%RH

The external visual inspection

With a single 1000±200lux fluorescent lamp as the light source, the inspection was in the distance of 30cm or more from the LCD to the inspector's eyes.

7.2 Light Method

Environment lamp under 1000±200 lux, Viewing direction for inspection over 30cmThe distance from eye to defect around 300mm, the distance from ND Filter to defect around 25~30mm



7.3 Classification of Defects

Minor defect

A major defect refers to a defect that may substantially degrade usability for product applications. **Minor defect**

A minor defect refers to a defect which is not considered to be able substantially degrade the Product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation.

Notes: If the LCD/LCM 's cosmetic and display performance do not specify in "inspection criterion", it should be based on these delivered samples.



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7.4 Sampling & Acceptable Quality Level

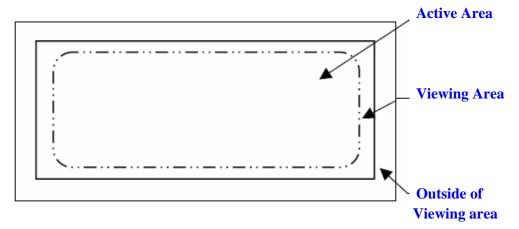
	Major	Minor
Cosmetic	1.0 %	1.5 %
Electrical-display	0.4%	0.65 %

Level II, MIL-STD-105E

7.5 Definition Of Inspection Area

V.A: Viewing Area

A.A: Active Area





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7.6 Items and Criteria

Visual inspection criterion in cosmetic

	Glass defect						
No	Defect	Criteria	Remark				
1	Dimension (Minor)	By engineering diagram					
2	Cracks (Major)	Extensive crack 【Reject】					

	LCD appearance defect with in V.A							
No	Defect	Criteria	1	Remark				
F '1 (1		Spec.	Permissible Qty	1. L: Length, W: Width				
	Fiber, scratches	$W \leq 0.03 mm$	Disregard	2. Disregard if out off A.A.				
1	(Major)	$\begin{array}{c} 0.03mm{<}\mathbb{W}{\leq}0.05mm\\ ,L{\leq}3.0mm \end{array}$	2					
		$\begin{array}{c} 0.05 mm {<} \mathbb{W} {\leq} 0.10 mm \\ , L {\leq} 3.0 mm \end{array}$	1					
		W>0.10mm or L>3.0mm	0	Ŵ				
	Dirty Spots,	Spec.	Permissible Qty	1. $\phi = (L+W)/2$, L: Length, W: Width				
	Round type	Round type	Round type		Round type	$\phi \leq 0.10$ mm	Disregard	2. Disregard if out of A.A.
2	(Major)	0.10 mm $< \phi \le 0.20$ mm	3	↓ W				
		$0.20\mathrm{mm} < arphi$	0	la l				
	Polarizer dent	Spec.	Permissible Qty	1. $\phi = (L+W)/2$, L: Length, W: Width				
	i olarizer dent	$\varphi \leq 0.20$ mm	Disregard	2. Disregard if out of A.A.				
3	(Major)	0.20 mm $< \varphi \le 0.30$ mm	2					
5	(Wajor)	0.30 mm $< \varphi \le 0.50$ mm	1					
		$0.50 \mathrm{mm} < \varphi$	0					



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	FPC							
No	Item	Criteria	Remark					
1	Copper Peeling (Minor)	Copper Peeling						

	Silicon							
No	Item	Criteria	Remark					
1	Amount of silicon (Minor)	ITO exposed						

LCD appearance defect								
No	Defect	Cr	iteria	Remark				
1	No display (Major)	Not allowable						
2	Missing line (Major)	Not allowable						
3	Darker or lighter line (Major)	By limited samp	le					
4	Dot defect (Major)	Spec. Bright dot Dark dot	Permissible Qty 1 2	1. dot =1R or 1G or 1B 2. Dot defect area \geq 1/2 dot 3. Disregard if out of AA area				
5	Mura (Minor)	By limited sample						



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	LCD appearance defect								
No	Defect	Criteria	Remark						
	Fiber, scratches	Spec.	Permissible Qty	1. L: Length, W: Width 2. Disregard if out off A.A.					
	(Major)	$W \leq 0.03 mm$	Disregard						
6		$0.03mm\!<\!\!\mathrm{W}\!\leq\!0.05mm$, L $\leq\!3.0mm$	2						
		$\begin{array}{c} 0.05 mm {<} \mathbb{W} {\leq} 0.10 mm \\ \text{, } L {\leq} 3.0 mm \end{array}$	1						
		W>0.10mm or L>3.0mm	0	W					
	Dirty spots	Spec.	Permissible Qty	1. $\phi = (L+W)/2$, L: Length, W: Width 2. Disregard if out of A.A.					
	(Major)	$\phi \leq 0.10$ mm	Disregard	2. Disregard in out of A.A.					
7		0.10 mm $< \phi \le 0.20$ mm	3	↓ w					
		$0.20\mathrm{mm} < arphi$	0						

Others

- 1. Issues that are not defined in this document shall be discussed and agreed with both parties. (Customer and supplier)
- 2. Unless otherwise agreed upon in writing, the criteria shall be applied to both parties. (Customer and supplier)



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8. **PRECAUTIONS**

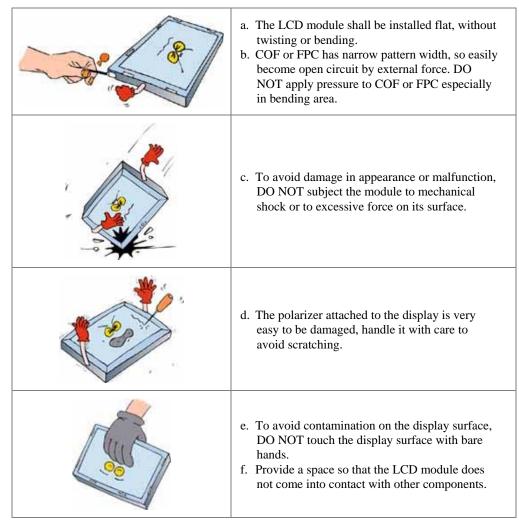
8.1 Operation

Burn-in sometimes happens when the same character was displayed at along time. Therefore, to prevent Burn-in, it is recommended to set up a Screen-saver function.

8.2 Safety

> The liquid crystal in the LCD is poisonous, DO NOT put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

8.3 Handling





///////// Microtips Technology Inc.

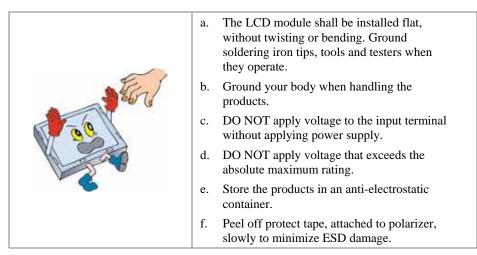
				Rev. No.	Issued Date.	Page.	
Product Specification	duct Specification Model:		MTF-TQ28NN911-LB		Feb.27,09	24/27	
	25	r		covering glass l) to keep appr	s (acrylic board or		
Critic				 h. Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur. 			
			 i. Property of semiconductor devices may be affected when they are exposed to light possibly resulting in malfunctioning of the ICs. To prevent such malfunctioning of the ICs, your design and mounting layout done are so that the IC is not exposed to light in actual use. 				
		000		exposure cause t may not reco	es degradation of ver		
	22	2	corrosion. 1. When it is no off or the pat by a screen s for a long pe	ot in use, the so itern must be fi aver. If it disp riod of time, b sticking may c	er to avoid Metal ereen must be turned requently changed lays the same patter rightness levelop due to the		
le Le	60	12	assemble the	es. If unqualified product after etion or its ope	ed operators or user disassembling it, it	s	



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8.4 Static electricity

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge.

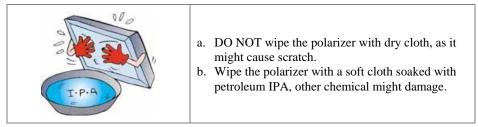


8.5 Storage

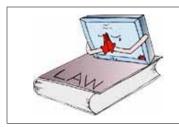


Store the products in a dark place at $+5 \sim +25$ degree C, low humidity (50% RH or less). DO NOT store the products in an atmosphere containing organic solvents or corrosive gases.

8.6 Cleaning



8.7 Waste



When dispose of LCD module, manage it at the production waste according to the relevant laws and regulations.



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9. WARRANTY

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1 13 months guarantee starts from the date code.
- 2 We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 3 We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- 4 We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- 5 We cannot accept responsibility for industrial property, which may arise through the use of your product, with exception to those issues relating directly to the structure or method of manufacturing of our product. Microtips-origin longer than one year from Microtips production.

10. DIMENSIONAL OUTLINES

See next page.....



Microtips Technology Inc.

